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Name: HITACHI, LTD.

Internal

Address: 6, Kanda Surugadai 4-chome, Chiyoda-ku

Street Address:

City: Tokyo, JAPAN State: Zip:Additional name(s) & address(es) attached? ☐ Yes ☒ No

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If this document is being filed together with a new application, the execution date of the application is: .

A. Patent Application No.(s)

B. Patent Registration No.(s)

10/819,307, filed April 7, 2004Additional number(s) attached ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Antonelli, Terry, Stout, and Kraus, LLP

Internal Address: 1300 North 17th Street – Suite 1800City: Arlington State: VA Zip: 222096. Total number of applications and patents involved 17. Total fee (37 CFR 3.41)..... \$40.00☒ Enclosed☒ Authorized to be charged to deposit account

8. Deposit account number:

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*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*NOT ASSIGNED TO ATTORNEY, Reg#

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PATENT
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W1527-01
(*)

ASSIGNMENT
(譲 渡 証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi, Ltd.,
a corporation organized under the laws of Japan,
located at 6, Kanda Surugadai 4-chome, Chiyoda-ku, Tokyo, Japan,
receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi, Ltd.,
its successors and assigns, all my right, title and interest, in and for the United States of America, in and to
**SHARED/EXCLUSIVE CONTROL SCHEME AMONG SITES INCLUDING STORAGE DEVICE
SYSTEM SHARED BY PLURAL HIGH-RANK APPARATUSES, AND COMPUTER SYSTEM
EQUIPPED WITH THE SAME CONTROL SCHEME**

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the
application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters
Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being
the entire ownership of the said Letters Patent when granted,
to be held and enjoyed by said Hitachi, Ltd.,
its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be
granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale
had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and
proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing,
continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension,
or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said
Hitachi, Ltd.,

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)
(発明者フルネームサイン)

Date Signed
(署名日)

1) <u>Kenichi Miki</u>	<u>April 7, 2004</u>
2) _____	_____
3) _____	_____
4) _____	_____
5) _____	_____
6) _____	_____
7) _____	_____
8) _____	_____
9) _____	_____
10) _____	_____